Image Filter with Coefficient RAM

FEATURES

- ☐ 66 MHz Data Input and Computation Rate
- ☐ Four 11 x 10-bit Multipliers with Individual Data and Coefficient Inputs and a 25-bit Accumulator
- ☐ Four 32 x 11-bit Serially Loadable Coefficient Registers
- ☐ Fractional or Integer Two's Complement Operands
- ☐ Package Styles Available:
 - 84-pin Plastic LCC, J-Lead
 - 100-pin Plastic Quad Flatpack
 - 84-pin Pin Grid Array

DESCRIPTION

The LF2247 consists of an array of four 11 x 10-bit registered multipliers followed by a summer and a 25-bit accumulator. The LF2247 provides a coefficient register file containing four 32 x 11-bit registers which are capable of storing 32 different sets of filter coefficients for the multiplier array. All multiplier data inputs are user accessible and can be updated every clock cycle with either fractional or integer two's complement data. The pipelined architecture has fully registered input and output ports and

an asynchronous three-state output enable control to simplify the design of complex systems. The pipeline latency for all inputs is five clock cycles.

A 25-bit accumulator path allows cumulative word growth which may be internally rounded to 16 bits. Output data is updated every clock cycle and may be held under user control. The data inputs/outputs and control inputs are registered on the rising edge of CLK. The Serial Data In signal, SDIN, is registered on the

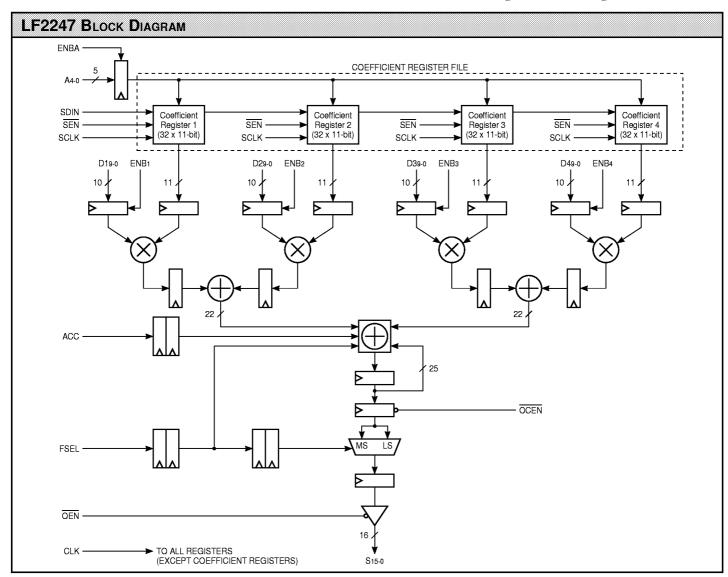
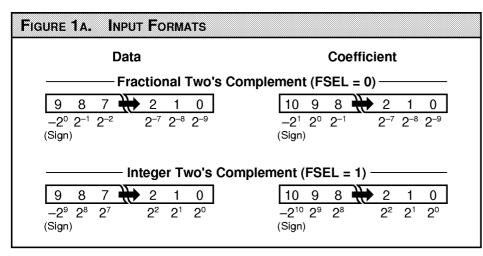
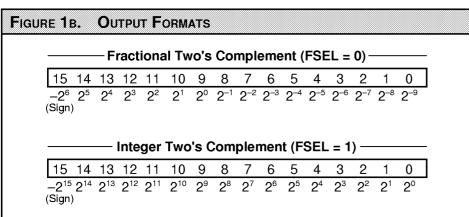


Image Filter with Coefficient RAM





rising edge of SCLK. The LF2247 operates at a clock rate of 66 MHz over the full temperature and supply voltage ranges.

The LF2247 is applicable for performing pixel interpolation in image manipulation and filtering applications. The LF2247 can perform a bilinear interpolation of an image (4-pixel kernels) at real-time video rates when used with an image resampling sequencer. Larger kernels or more complex functions can be realized by utilizing multiple devices.

Unrestricted access to all data ports and an addressable coefficient register file provides the LF2247 with considerable flexibility in applications such as digital filters, adaptive FIR filters, mixers, and other similar systems requiring high-speed processing.

SIGNAL DEFINITIONS

Power

VCC and GND

+5 V power supply. All pins must be connected.

Clocks

CLK - Master Clock

The rising edge of CLK strobes all enabled registers except for the coefficient registers.

SCLK — Serial Clock

The rising edge of SCLK shifts data into and through the coefficient register file when it is enabled for serial data shifting.

Inputs

D19-0 - D49-0 — Data Input

D1-D4 are the 10-bit registered data input ports. Data is latched on the rising edge of CLK.

A4-0 — Row Address

A4-0 determines which row of data in the coefficient register file is used to feed data to the multiplier array. A4-0 is latched on the rising edge of CLK. When a new row address is loaded into the row address register, data from the register file will be latched into the multiplier input registers on the next rising edge of CLK.

SDIN — Serial Data Input

SDIN is used to serially load data into the coefficient registers. Data present on SDIN is shifted into the coefficient register file on the rising edge of SCLK when $\overline{\text{SEN}}$ is LOW. The 11-bit coefficients are loaded into the coefficient register file in 16-bit words as shown in Figure 2. The five most significant bits of the first 16-bit word determine which row the data is written to in the coefficient registers. Note that the five most significant bits of the remaining three 16-bit words are ignored. After all four 16-bit words are shifted into the register file, the lower eleven bits of each word (the coefficient data) are stored into the coefficient registers.

Outputs

S₁₅₋₀ — Data Output

S₁₅₋₀ is the 16-bit registered data output port.

Controls

ENB1-ENB4 — Data Input Enables

The ENBN (N = 1, 2, 3, or 4) inputs allow the DN registers to be updated on each clock cycle. When ENBN is LOW, data on DN9-0 is latched into

Image Filter with Coefficient RAM

the DN register on the rising edge of CLK. When ENBN is HIGH, data on DN9-0 is not latched into the DN register and the register contents will not be changed.

ENBA — Row Address Input Enable

The ENBA input allows the row address register to be updated on each clock cycle. When ENBA is LOW, data on A4-0 is latched into the row address register on the rising edge of CLK. When ENBA is HIGH, data on A4-0 is not latched into the row address register and the register contents will not be changed.

OEN — Output Enable

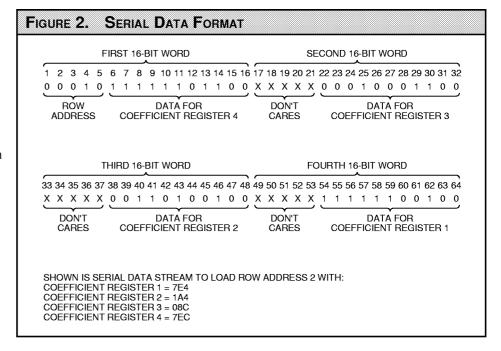
When \overline{OEN} is LOW, S15-0 is enabled for output. When \overline{OEN} is HIGH, S15-0 is placed in a high-impedance state.

OCEN — Clock Enable

When OCEN is LOW, data in the premux register (accumulator output) is loaded into the output register on the next rising edge of CLK. When OCEN is HIGH, data in the pre-mux register is held preventing the output register's contents from changing (if FSEL does not change). Accumulation continues internally as long as ACC is HIGH, despite the state of OCEN.

FSEL — Format Select

When FSEL is LOW, the data input during the current clock cycle is assumed to be in fractional two's complement format, and the upper 16 bits of the accumulator are presented at the output. Rounding of the accumulator result to 16 bits is per-



formed if the accumulator control input ACC is LOW. When FSEL is HIGH, the data input is assumed to be in integer two's complement format, and the lower 16 bits of the accumulator are presented at the output. No rounding is performed when FSEL is HIGH.

ACC — Accumulator Control

The ACC input determines whether internal accumulation is performed on the data input during the current clock cycle. If ACC is LOW, no accumulation is performed, the prior accumulated sum is cleared, and the current sum of products is output. If FSEL is also LOW, one-half LSB rounding to 16 bits is performed on the result. When ACC is HIGH, the emerging product is added to the sum of the previous products, without additional rounding.

SEN — Serial Input Enable

The SEN input enables the shifting of serial data through the registers in the coefficient register file. When SEN is LOW, serial data on SDIN is shifted into the coefficient register file on the rising edge of SCLK. SEN must remain LOW until all four coefficients have been clocked in. SEN does not need to be pulsed between consecutive data sets. It can remain LOW while the entire register file is loaded by a constant bit stream. When \overline{SEN} is HIGH, data can not be shifted into the register file and the register file's contents will not be changed. When enabling the coefficient register file for serial data input, the LF2247 requires a HIGH to LOW transition of SEN in order to function properly. Therefore, SEN needs to be set HIGH immediately after power up to ensure proper operation of the serial input circuitry.



XIMUM RATINGS Above which useful life may be impaired (Notes 1, 2, 3, 8)				
Storage temperature	–65°C to +150°C			
Operating ambient temperature	–55°Cto +125°C			
Vcc supply voltage with respect to ground	0.5 V to +7.0 V			
Input signal with respect to ground	0.5 V to Vcc + 0.5 V			
Signal applied to high impedance output	0.5 V to Vcc + 0.5 V			
Output current into low outputs	25 mA			
Latchup current	> 400 mA			

OPERATING CONDITIONS To meet spec	ified electrical and switching characteri	stics
Mode	Temperature Range (Ambient)	Supply Voltage
Active Operation, Commercial	0°C to +70°C	4.75 V≤ V cc ≤ 5.25 V
Active Operation, Military	−55°C to +125°C	4.50 V ≤ V CC ≤ 5.50 V

ELECTRI	CAL CHARACTERISTICS Ove	er Operating Conditions (Note 4)				
Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
V OH	Output High Voltage	V CC = Min., IOH = −2.0 mA	2.4			٧
V OL	Output Low Voltage	VCC = Min., IOL = 4.0 mA			0.4	٧
V IH	Input High Voltage		2.0		Vcc	٧
V IL	Input Low Voltage	(Note 3)	0.0		0.8	٧
lix	Input Current	Ground ≤ Vin ≤ Vcc (Note 12)			±10	μΑ
loz	Output Leakage Current	Ground \leq V OUT \leq V CC (Note 12)			±40	μΑ
ICC1	Vcc Current, Dynamic	(Notes 5, 6)			100	mA
ICC2	Vcc Current, Quiescent	(Note 7)			6.0	mA
CIN	Input Capacitance	T A = 25°C, f = 1 MHz			10	рF
Соит	Output Capacitance	T A = 25°C, f = 1 MHz			10	pF

Image Filter with Coefficient RAM

SWITCHING CHARACTERISTICS

Commercial Operating Range (0°C to +70°C) Notes 9, 10 (ns)							
				LF2	247–		
		33 25 15			5		
Symbol	Parameter	Min	Max	Min	Max	Min	Max
tcyc	Cycle Time	33		25		15	
t PWL	Clock Pulse Width Low	15		10		7	
t PWH	Clock Pulse Width High	10		10		7	
ts	Input Setup Time	10		8		5	
tн	Input Hold Time	0		0		0	
t D	Output Delay		15		13		11
tDIS	Three-State Output Disable Delay (Note 11)		15		15		15
t ENA	Three-State Output Enable Delay (Note 11)		15		15		15

MILITAR	MILITARY OPERATING RANGE (-55°C to +125°C) Notes 9, 10 (ns)					
		LF2		247–		
		3	3	2	:5	
Symbol	Parameter	Min	Max	Min	Max	
t CYC	Cycle Time	33		25		
t PWL	Clock Pulse Width Low	15		10		
t PWH	Clock Pulse Width High	10		10		
t s	Input Setup Time	10		8		
tH	Input Hold Time	0		0		
t D	Output Delay		15		13	
tDIS	Three-State Output Disable Delay (Note 11)		15		15	
t ENA	Three-State Output Enable Delay (Note 11)		15		15	

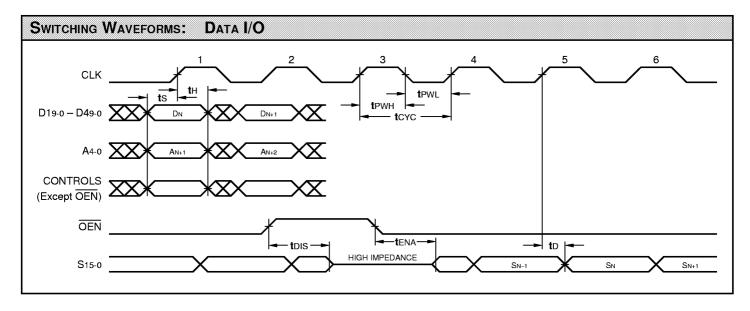
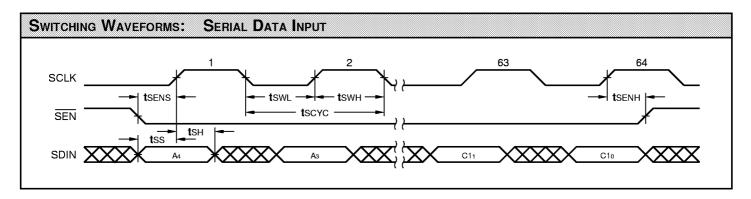


Image Filter with Coefficient RAM

SWITCHING CHARACTERISTICS

Сомме	Commercial Operating Range (0°C to +70°C) Notes 9, 10 (ns)							
		LF2247-						
		3	3	2	:5	1	15	
Symbol	Parameter	Min	Max	Min	Max	Min	Max	
tscyc	Serial Interface Cycle Time	62		62		62		
tswL	Serial Clock Pulse Width Low	30		30		30		
tswH	Serial Clock Pulse Width High	30		30		30		
t SENS	Serial Enable Setup Time	20		20		20		
t SENH	Serial Enable Hold Time	0		0		0		
tss	Serial Data Input Setup Time	20		20		20		
t sH	Serial Data Input Hold Time	0		0		0		

MILITAR	MILITARY OPERATING RANGE (-55°C to +125°C) Notes 9, 10 (ns)				
		LF2247-			
		3	3	25	
Symbol	Parameter	Min	Max	Min	Max
tscyc	Serial Interface Cycle Time	62		62	
tswL	Serial Clock Pulse Width Low	30		30	
tswn	Serial Clock Pulse Width High	30		30	
tSENS	Serial Enable Setup Time	20		20	
t SENH	Serial Enable Hold Time	0		0	
tss	Serial Data Input Setup Time	20		20	
t sH	Serial Data Input Hold Time	0		0	



6

Image Filter with Coefficient RAM

NOTES

- 1. Maximum Ratings indicate stress specifications only. Functional operation of these products at values beyond those indicated in the Operating Conditions table is not implied. Exposure to maximum rating conditions for extended periods may affect reliability.
- 2. The products described by this specification include internal circuitry designed to protect the chip from damaging substrate injection currents and accumulations of static charge. Nevertheless, conventional precautions should be observed during storage, handling, and use of these circuits in order to avoid exposure to excessive electrical stress values.
- 3. This device provides hard clamping of transient undershoot and overshoot. Input levels below ground or above VCC will be clamped beginning at $-0.6\,\mathrm{V}$ and VCC + $0.6\,\mathrm{V}$. The device can withstand indefinite operation with inputs in the range of $-0.5\,\mathrm{V}$ to $+7.0\,\mathrm{V}$. Device operation will not be adversely affected, however, input current levels will be well in excess of $100\,\mathrm{mA}$.
- 4. Actual test conditions may vary from those designated but operation is guaranteed as specified.
- 5. Supply current for a given application can be accurately approximated by:

 $\frac{NCV^2F}{4}$

where

N = total number of device outputs

C = capacitive load per output

V = supply voltage

F = clock frequency

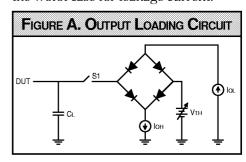
- 6. Tested with all outputs changing every cycle and no load, at a 30 MHz clock rate.
- 7. Tested with all inputs within 0.1 V of VCC or Ground, no load.
- 8. These parameters are guaranteed but not 100% tested.

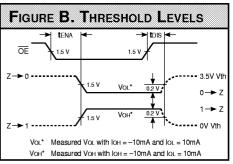
9. AC specifications are tested with input transition times less than 3 ns, output reference levels of 1.5 V (except tDIS test), and input levels of nominally 0 to 3.0 V. Output loading may be a resistive divider which provides for specified IOH and IOL at an output voltage of VOH min and VOL max respectively. Alternatively, a diode bridge with upper and lower current sources of IOH and IOL respectively, and a balancing voltage of 1.5 V may be used. Parasitic capacitance is 30 pF minimum, and may be distributed.

This device has high-speed outputs capable of large instantaneous current pulses and fast turn-on/turn-off times. As a result, care must be exercised in the testing of this device. The following measures are recommended:

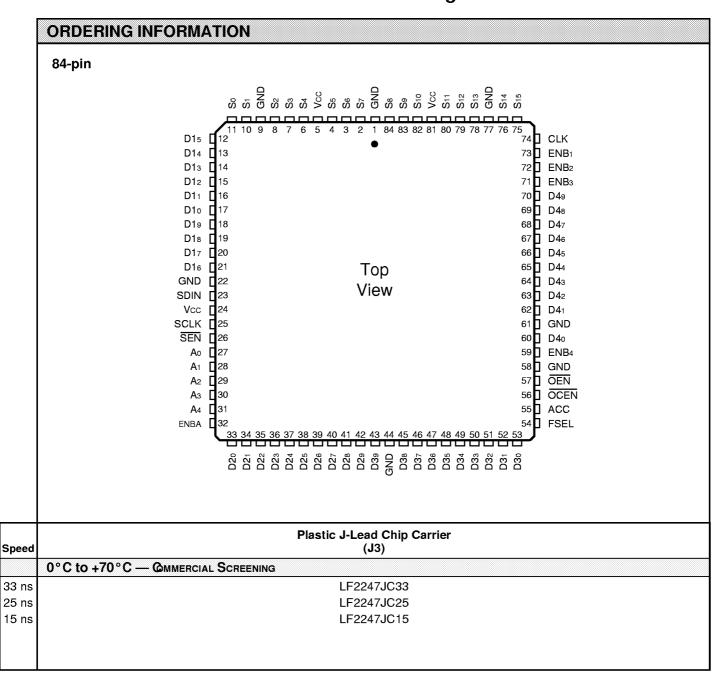
- a. A 0.1 μF ceramic capacitor should be installed between VCC and Ground leads as close to the Device Under Test (DUT) as possible. Similar capacitors should be installed between device VCC and the tester common, and device ground and tester common.
- b. Ground and VCC supply planes must be brought directly to the DUT socket or contactor fingers.
- 10. Each parameter is shown as a minimum or maximum value. Input requirements are specified from the point of view of the external system driving the chip. Setup time, for example, is specified as a minimum since the external system must supply at least that much time to meet the worst-case requirements of all parts. Responses from the internal circuitry are specified from the point of view of the device. Output delay, for example, is specified as a maximum since worst-case operation of any device always provides data within that time.

- 11. For the tena test, the transition is measured to the 1.5 V crossing point with datasheet loads. For the tDIS test, the transition is measured to the $\pm 200 \text{mV}$ level from the measured steady-state output voltage with $\pm 10 \text{mA}$ loads. The balancing voltage, VTH, is set at 3.5 V for Z-to-0 and 0-to-Z tests, and set at 0 V for Z-to-1 and 1-to-Z tests.
- 12. These parameters are only tested at the high temperature extreme, which is the worst case for leakage current.

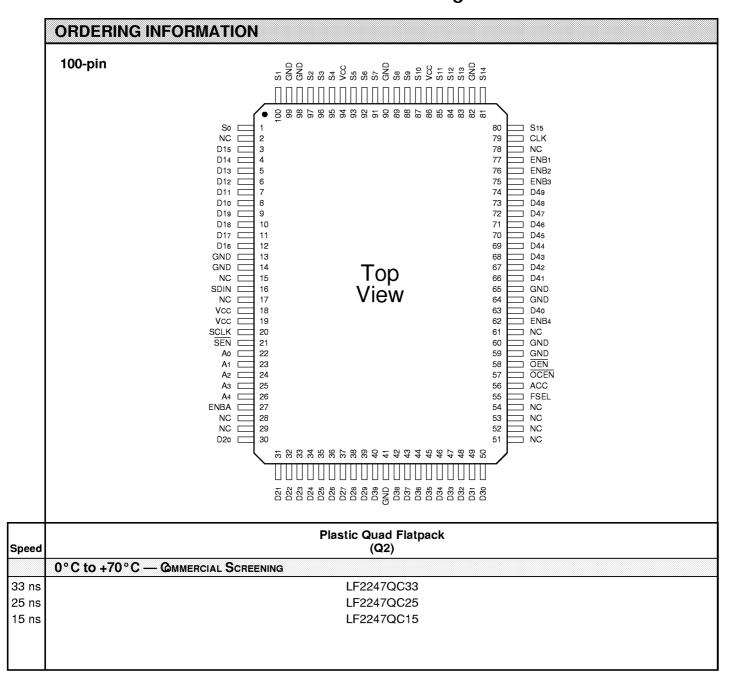














	ORDERING INFORMATION
	84-pin
	1 2 3 4 5 6 7 8 9 10 11
A V	B
	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$
	H
ed	Ceramic Pin Grid Array (G3)
ns	0°C to +70°C — @mmercial Screening LF2247GC33
ns ns	LF2247GC25 LF2247GC15
	-55°C to +125°C — @mmercial Screening
	-55°C to +125°C — MIL-STD-883 @mpLiant

